Ceramic

Bandpass Filter

BFCN-1860+

50Ω 1580 to 2200 MHz

The Big Deal

- LTCC construction
- Temperature stable from -55 to +100°C
- Small size (0.126 x .063 X .037")



CASE STYLE: FV1206-4

Product Overview

The BFCN-1860+ LTCC bandpass filter covers the 1580 to 2200 MHz passband with 2 dB passband insertion loss and 20 dB upper/lower stopband rejection. This model handles up to 2.5W RF input power and provides a wide operating temperature range from -55 to +100°C. Utilizing LTCC multi-layer construction, the filter achieves excellent repeatability of performance and comes in a tiny 1206 ceramic package with wraparound terminations, minimizing performance variations due to parasitics and saving space in dense PCB layouts.

Key Features

Feature	Advantages
LTCC Construction	Provides a rugged package well suited for tough environments such as high humidity and temperature extremes.
Tiny size (0.126 x .063 x .037")	Saves space in dense circuit boards and minimizes the effects of parasitics.
Wrap-around terminations	Provides excellent solderability and easy visual inspection
Wide operating temperature range, -55 to +100°C	Enables reliable performance in extreme environments

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Features

- Good VSWR, 1.5:1 typ. @ passband
- Small size(0.126 x .063 x .037)
- Temperature stable
- LTCC construction

Applications

- · Harmonic rejection
- Transmitters / Receivers

BFCN-1860+



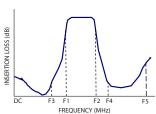
Generic photo used for illustration purposes only

CASE STYLE: FV1206-4

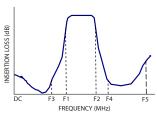
+RoHS Compliant

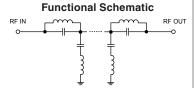
The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications



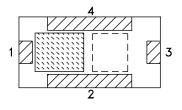


Specification Definition





Top View



Pad Connections

Input	1
Output	3
Ground	2,4

Electrical Specifications^{1,2} at 25°C

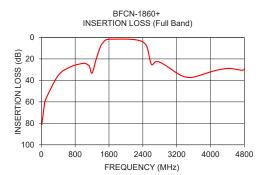
Paran	neter	F#	Frequency (MHz)	Min. Typ. Max.		Max.	Unit
	Center Frequency	_			1860		MHz
Pass Band	Insertion Loss	F1 - F2	1580 - 2200	_	2.0	3.5	dB
	VSWR	F1 - F2	1580 - 2200	_	1.5	2.5	:1
Cton Bond Lower	Insertion Loss	DC - F3	1300	_	20	_	dB
Stop Band, Lower	VSWR	DC - F3	1300	_	20	_	:1
Ston Bond Unner	Insertion Loss	F4 - F5	2600 - 4800	_	20	_	dB
Stop Band, Upper	VSWR	F4 - F5	2600 - 4800	_	15	_	:1

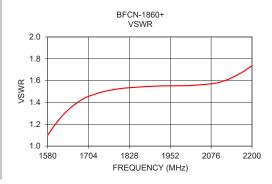
- Measured on Mini-Circuits Characterization Test Board TB-824+.
 This filter is not intended for use as a DC Blocking circuit element. In Application where DC voltage is present at either input or output ports, blocking capacitors are required at the corresponding RF port

Maximum Ratings

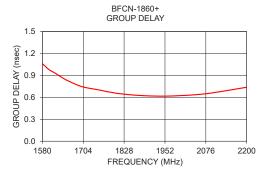
Operating Temperature	-55°C to +100°C
Storage Temperature	-55°C to +100°C
RF Power Input*	2.5W at 25°C

*Passband rating, derate linearly to 0.7W at 100°C ambient Permanent damage may occur if any of these limits are exceeded.





BFCN-1860+ INSERTION LOSS (Pass Band) 0.0 원 0.5 **INSERTION LOSS** 1.0 2.0 1580 1704 1828 1952 2076 2200 FREQUENCY (MHz)



Full Band Performance

Pass Band Performance

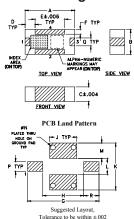
Frequency (MHz)	Insertion Loss (dB)	VSWR (:1)	Frequency (MHz)	Insertion Loss (dB)	Group Delay (nsec)
10	81.30	72.38	1580	1.78	1.06
40	72.24	67.32	1600	1.71	0.98
100	57.92	60.68	1620	1.66	0.93
400	35.41	43.01	1640	1.62	0.87
1000	24.12	22.58	1660	1.61	0.82
1300	19.87	10.75	1700	1.58	0.75
1580	1.78	1.10	1750	1.56	0.70
1660	1.61	1.38	1800	1.54	0.66
2000	1.56	1.55	1850	1.53	0.63
2200	2.00	1.74	1900	1.53	0.62
2600	24.98	5.02	1950	1.54	0.62
3000	27.70	17.47	2000	1.56	0.62
3500	37.29	23.88	2050	1.60	0.64
4100	31.00	24.03	2100	1.68	0.66
4800	30.01	2.93	2200	2.00	0.74

Pad Connections

Input	1
Output	3
Ground	2,4

Product Marking: GK

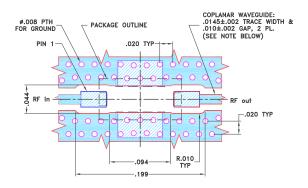
Outline Drawing



Outline Dimensions (inch)

J	Н	G	F	E	D	С	В	Α
.069	.104	.182	.012	.075	.026	.037	.063	.126
1.75	2.64	4.62	0.30	1.91	0.66	0.94	1.60	3.20
wt		R	Q	Р	N	М	L	K
grams		.039	.020	.024	.013	.039	.041	.119
.020		0.99	0.51	0.61	0.33	0.99	1.04	3.02

Demo Board MCL P/N: TB-824+ Suggested PCB Layout (PL-454)



- INTEGE WIDTH PARAMETERS ARE SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .0066"±.0007". COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED. 2. BOTTOM SIDE OF THE PCB IS CONTIN
- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER). DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

Additional Notes

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp

